# LCG H9RM

#### **OSRAM OSTAR® Projection Cube**

OSRAM OSTAR Projection Cube is a high flux LED for slim designs.







#### **Applications**

- Projection Home LED & Laser

- Projection Mobile (LED & Laser)

#### Features:

- Package: SMD epoxy package

Chip technology: UX:3

Typ. Radiation: 120° (Lambertian emitter)

— Color: Cx = 0.318, Cy = 0.642 acc. to CIE 1931 (● converted green)

- Corrosion Robustness Class: 3B

- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)

## **Ordering Information**

Туре	Luminous Flux <sup>1)</sup> $I_F = 350 \text{ mA}$ $\Phi_V$	Ordering Code	
LCG H9RM-LXMX-1	112 210 lm	Q65112A6831	



#### LCG H9RM

Maximum Ratings			
Parameter	Symbol		Values
Operating Temperature	T <sub>op</sub>	min.	-40 °C
	op.	max.	100 °C
Storage Temperature	T <sub>stg</sub>	min.	-40 °C
	3.9	max.	100 °C
Junction Temperature	$T_{j}$	max.	150 °C
Forward Current	I <sub>E</sub>	min.	100 mA
$T_S = 25  ^{\circ}C$	·	max.	500 mA
Forward Current pulsed D = 0.5; f = 120 Hz; T <sub>S</sub> = 25 °C	I <sub>F pulse</sub>	max.	1000 mA
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	$V_{ESD}$		8 kV
Reverse current 2)	I <sub>R</sub>	max.	200 mA



#### LCG H9RM

### **Characteristics**

 $I_{\scriptscriptstyle F}$  = 350 mA;  $T_{\scriptscriptstyle S}$  = 25 °C

Parameter	Symbol		Values
Chromaticity Coordinate 3)	Сх	typ.	0.318
acc. to CIE 1931 within λ = 500 600 nm	Су	typ.	0.642
Viewing angle at 50 % I <sub>v</sub>	2φ	typ.	120 °
Radiating surface	$A_{color}$	typ.	0.72 x 0.72 mm²
Partial Flux acc. CIE 127:2007 4) $\Phi_{E/V  120^{\circ}} = x * \Phi_{E/V  180^{\circ}}$	Φ <sub>E/V, 120°</sub>	typ.	0.77
Forward Voltage 5)	$V_{F}$	min.	2.70 V
$I_{\rm F} = 350 \text{ mA}$	·	typ.	2.97 V
		max.	3.50 V
Reverse voltage (ESD device)	V <sub>R ESD</sub>	min.	45 V
Reverse voltage <sup>2)</sup> I <sub>R</sub> = 20 mA	$V_R$	max.	1.2 V
Real thermal resistance junction/solderpoint <sup>6)</sup>	R <sub>thJS real</sub>	typ.	20 K / W
	uioo igai	max.	25 K / W
Electrical thermal resistance junction/solderpoint <sup>6)</sup>	R <sub>thJS elec.</sub>	typ.	14 K / W
with efficiency $\eta_e$ = 29 %	2.52 2.55	max.	18 K / W

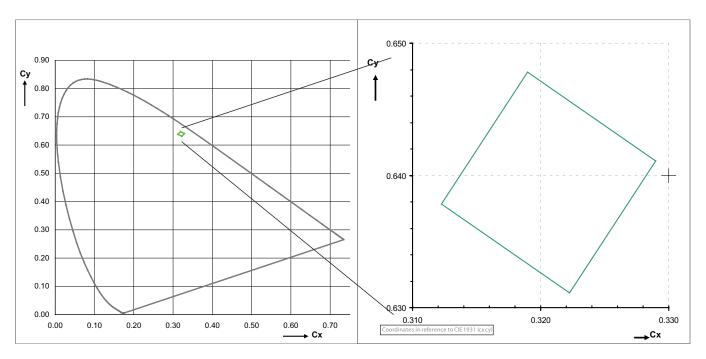
# **Brightness Groups**

Group	Luminous Flux 1)	Luminous Flux 1)	Luminous Intensity 4)	
	$I_{F} = 350 \text{ mA}$	$I_{\rm F} = 350 \text{ mA}$	$I_{F} = 350 \text{ mA}$	
	min.	max.	typ.	
	$\Phi_{V}$	$\Phi_{V}$	I <sub>v</sub>	
LX	112 lm	130 lm	41 cd	
LY	130 lm	150 lm	47 cd	
LZ	150 lm	180 lm	55 cd	
MX	180 lm	210 lm	66 cd	



## **Chromaticity Coordinate Groups** 3)

within  $\lambda = 500 ... 600 \text{ nm}$ 



## Color Chromaticity Groups 3)

Group	Сх	Су
1	0.3123	0.6378
	0.3190	0.6478
	0.3290	0.6411
	0.3223	0.6311

## **Group Name on Label**

Example: LX-1

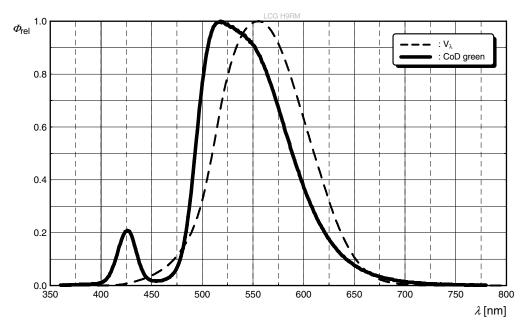
Brightness Color Chromaticity

LX 1



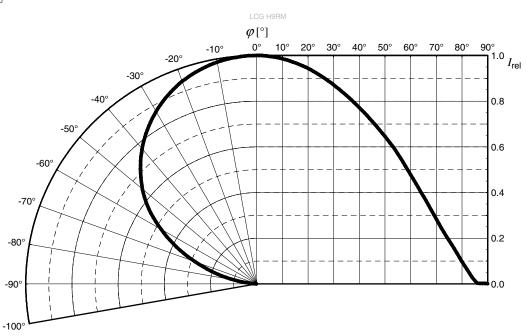
## Relative Spectral Emission 4)

$$\Phi_{rel}$$
 = f ( $\lambda$ ); I<sub>F</sub> = 350 mA; T<sub>J</sub> = 25 °C



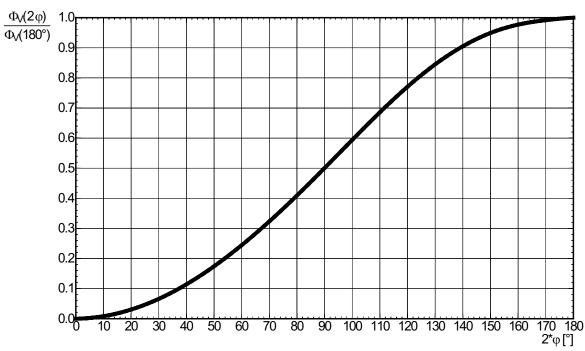
### Radiation Characteristics 4)

$$I_{rel} = f (\phi); T_J = 25 °C$$



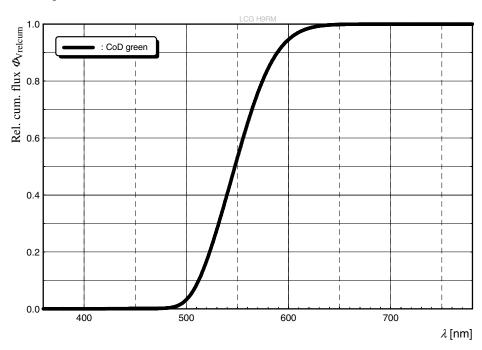
#### Relative Partial Flux 4)

 $\Phi_{V}(2\phi)/\Phi_{V}(180^{\circ}) = f(\phi); T_{J} = 25 \, ^{\circ}C$ 



## Relative cumulated Luminous Flux 4)

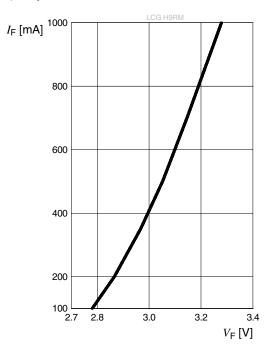
$$\Phi_{\text{Vrel-cum}}$$
 = f ( $\lambda$ ); I<sub>F</sub> = 350 mA; T<sub>J</sub> = 25 °C





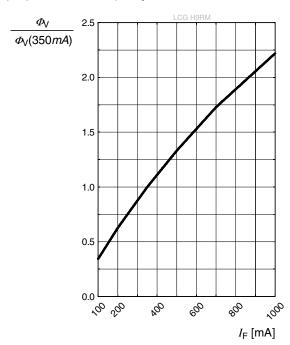
#### Forward current 4), 7)

$$I_F = f(V_F); T_J = 25 °C$$



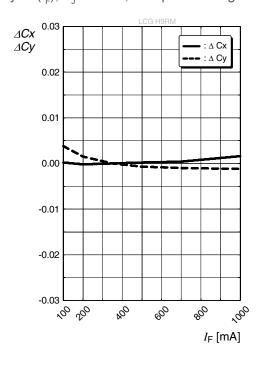
## Relative Luminous Flux 4), 7)

 $\Phi_{V}/\Phi_{V}(350 \text{ mA}) = f(I_{F}); T_{J} = 25 \text{ }^{\circ}\text{C}$ 



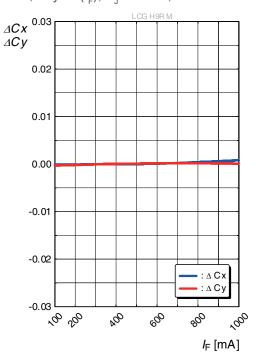
### **Chromaticity Coordinate Shift** 4)

 $\Delta Cx$ , $\Delta Cy = f(I_F)$ ;  $T_J = 25$  °C; full spectral range



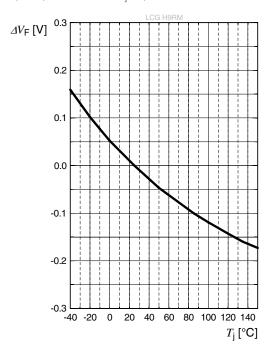
## **Chromaticity Coordinate Shift** 4)

 $\Delta Cx$ , $\Delta Cy = f(I_E)$ ;  $T_J = 25$  °C; within  $\lambda = 500 \dots 600$  nm



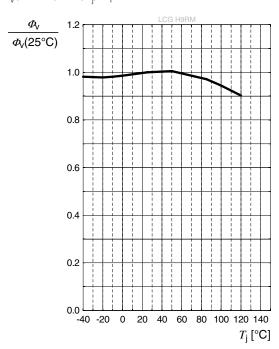
#### Forward Voltage 4)

$$\Delta V_F = V_F - V_F (25 \ ^{\circ}C) = f(T_j); I_F = 350 \ mA$$



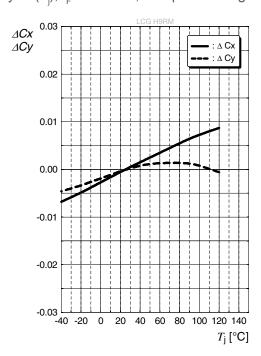
#### Relative Luminous Flux 4)

$$\Phi_{V}/\Phi_{V}(25 \text{ °C}) = f(T_{i}); I_{F} = 350 \text{ mA}$$



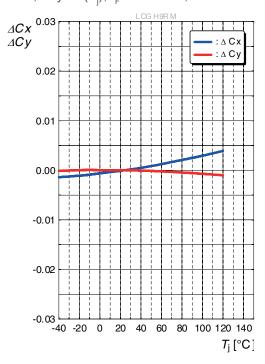
### **Chromaticity Coordinate Shift** 4)

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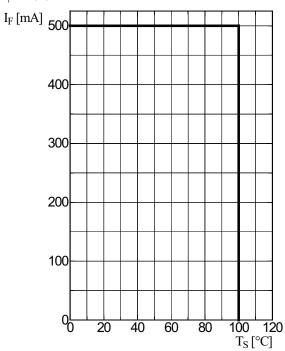
## **Chromaticity Coordinate Shift** 4)

 $\Delta Cx$ , $\Delta Cy = f(T_i)$ ;  $I_F = 350$  mA; within  $\lambda = 500$  ... 600 nm



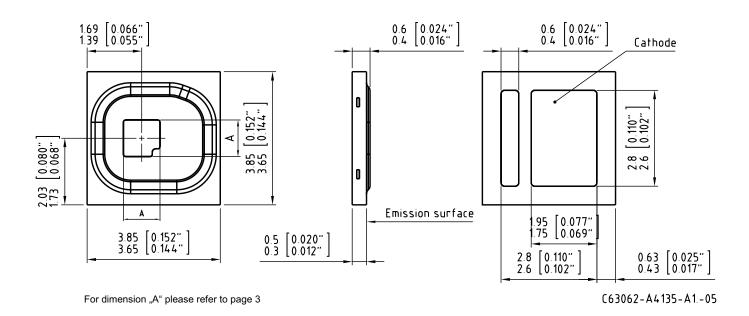
## Max. Permissible Forward Current

 $I_F = f(T)$ 





## **Dimensional Drawing** 8)



**Approximate Weight:** 22.0 mg

Corrosion test: Class: 3B

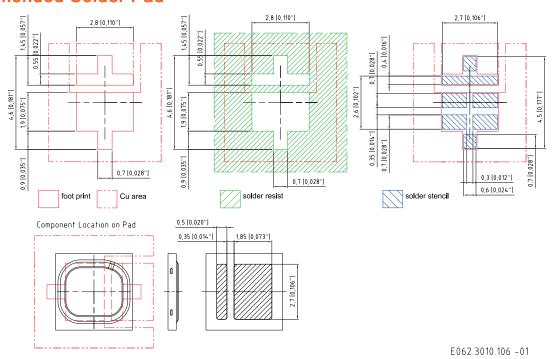
Test condition: 40°C / 90 % RH / 15 ppm H<sub>2</sub>S / 14 days (stricter then IEC

60068-2-43)

**ESD advice:** The device is protected by ESD device which is connected in parallel to the

Chip.

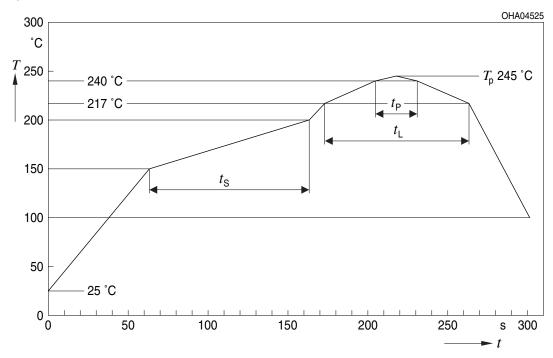
#### Recommended Solder Pad 8)



For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. In case the PCB layout of the application is intended to be used with other OSLON derivates or in future developed OSLON derivates, the heat sink must not be electrically connected to anode or cathode solder pad because of possible chip inverted polarity. Package not suitable for ultra sonic cleaning.

### **Reflow Soldering Profile**

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



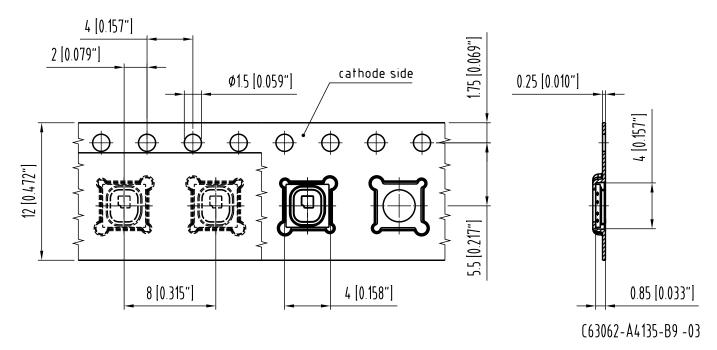
Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*)	'		2	3	K/s
25 °C to 150 °C					
Time t <sub>s</sub>	t <sub>s</sub>	60	100	120	S
$T_{Smin}$ to $T_{Smax}$					
Ramp-up rate to peak*)			2	3	K/s
$T_{Smax}$ to $T_{P}$					
Liquidus temperature	$T_L$		217		°C
Time above liquidus temperature	$t_{\scriptscriptstyle L}$		80	100	S
Peak temperature	$T_{P}$		245	260	°C
Time within 5 °C of the specified peak	t <sub>P</sub>	10	20	30	S
temperature T <sub>P</sub> - 5 K					
Ramp-down rate*			3	6	K/s
T <sub>P</sub> to 100 °C					
Time				480	S
25 °C to T <sub>P</sub>					

All temperatures refer to the center of the package, measured on the top of the component

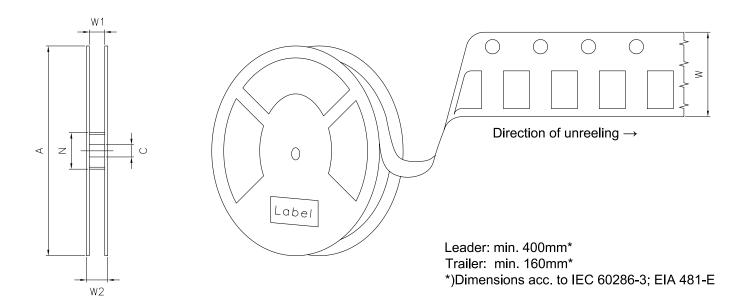


<sup>\*</sup> slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

# Taping 8)



## Tape and Reel 9)



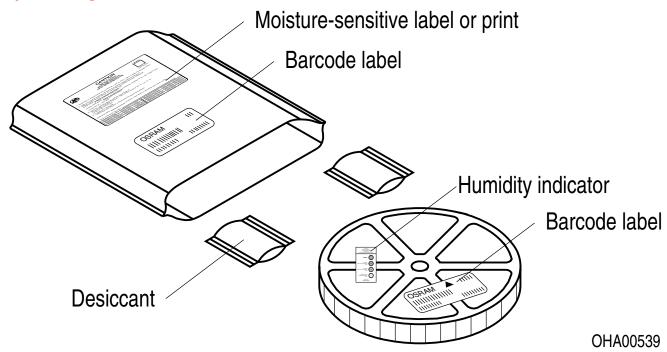
# Reel dimensions [mm]

Α	W	$N_{\text{min}}$	$W_1$	$W_{2 max}$	Pieces per PU
180 mm	12 + 0.3 / - 0.1	60	12.4 + 2	18.4	2000

#### **Barcode-Product-Label (BPL)**



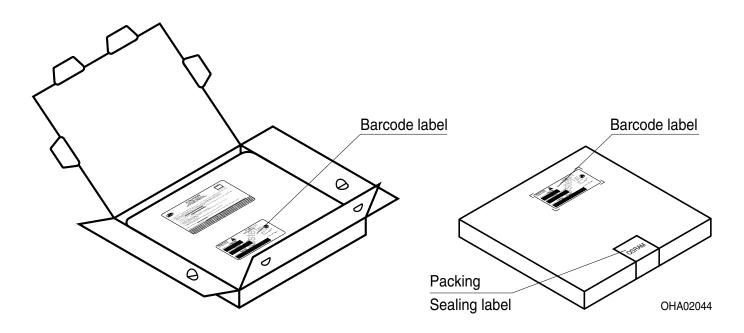
### Dry Packing Process and Materials 8)



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



# Transportation Packing and Materials 8)

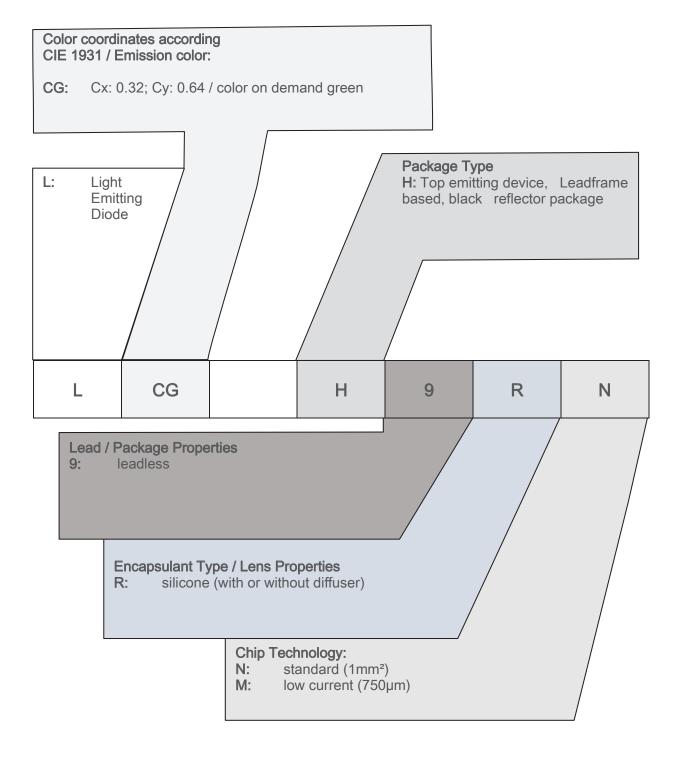


# Dimensions of transportation box in mm

Width	Length	Height
195 ± 5 mm	195 ± 5 mm	30 ± 5 mm



### **Type Designation System**



#### **Notes**

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class **low risk (exposure time 100 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related informations please visit www.osram-os.com/appnotes



#### **Disclaimer**

#### Disclaimer

Language english will prevail in case of any discrepancies or deviations between the two language wordings.

#### Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS webside.

#### **Packing**

Please use the recycling operators known to you. We can also help you – get in touch with your nearest

By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

#### Product safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

In case Buyer - or Customer supplied by Buyer- considers using OSRAM OS components in product safety devices/applications or medical devices/applications, Buyer and/or Customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and Buyer and /or Customer will analyze and coordinate the customer-specific request between OSRAM OS and Buyer and/or Customer.



#### Glossary

- Brightness: Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of  $\pm 8$  % and an expanded uncertainty of  $\pm 11$  % (acc. to GUM with a coverage factor of k = 3).
- Reverse Operation: Reverse Operation of 10 hours is permissible in total. Continuous reverse operation is not allowed.
- Chromaticity coordinate groups: Chromaticity coordinates are measured during a current pulse of typically 25 ms, with an internal reproducibility of  $\pm 0.005$  and an expanded uncertainty of  $\pm 0.01$  (acc. to GUM with a coverage factor of k = 3).
- Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- Forward Voltage: The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of  $\pm 0.05$  V and an expanded uncertainty of  $\pm 0.1$  V (acc. to GUM with a coverage factor of k = 3).
- Thermal Resistance: Rth max is based on statistic values  $(6\sigma)$ .
- Characteristic curve: In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- <sup>9)</sup> **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



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